



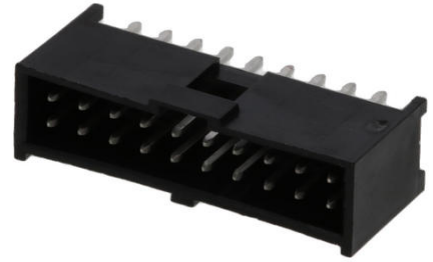
**Part Number :** [901301120](#)

**Product Description :** C-Grid III PCB Header, 2.54mm Pitch, Through Hole, Dual Row, Vertical, Shrouded, 2.90mm Tail Length, 20 Circuits, Tin (Sn) Plating

**Series Number :** 90130

**Status :** Active

**Product Category :** PCB Headers and Receptacles



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## Documents and Resources

### Drawings

[901301120 sd.pdf](#)

[PK-91814-005-001.pdf](#)

### 3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

[Symbol and Footprint \(Multi-Format\)](#)

### Specifications

[901190001-AS-000.pdf](#)


[PK-90130-001-001.pdf](#)

[PS-99020-0001-001.pdf](#)

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## Product Environment Compliance

### Compliance

GADSL/IMDS	Compliant with Exemption 44; 33
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)

EU RoHS	Compliant per EU 2015/863
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### Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

### Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

### Substances of Interest

- PFAS

### EU RoHS Certificate of Compliance

### Additional Product Compliance Information

## Part Details

### General

Status	Active
Category	PCB Headers and Receptacles
Series	90130
Description	C-Grid III PCB Header, 2.54mm Pitch, Through Hole, Dual Row, Vertical, Shrouded, 2.90mm Tail Length, 20 Circuits, Tin (Sn) Plating
Application	Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid III
UPC	800753700161

### Agency

CSA	LR19980
UL	E29179

### Electrical

Current - Maximum per Contact	3.0A
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Voltage - Maximum	350V AC/DC
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## Physical

Breakaway	No
Circuits (Loaded)	20
Circuits (maximum)	20
Color - Resin	Black
Durability (mating cycles max)	30
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	No
Lock to Mating Part	Yes
Material - Metal	Brass
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	Polyester
Net Weight	2.318/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	No
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.90mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	3.000µm
Plating min - Termination	3.000µm
Polarized to Mating Part	Yes
Polarized to PCB	No
Shrouded	Shrouded
Stackable	No
Temperature Range - Operating	-55° to +125°C
Termination Interface Style	Through Hole

## Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	235

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## Mates With / Use With

### Mates with Part(s)

Description	Part Number
C-Grid III Dual Row Crimp Housings	<u>90142</u>
C-Grid III Modular Dual Row Crimp Housings	<u>90143</u>

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